# CY54/74FCT163T

SCCS015 - May 1994 - Revised February 2000

#### **Features**

- Function, pinout, and drive compatible with FCT and F logic
- FCT-C speed at 5.8 ns max. (Com'l),
- Reduced V<sub>OH</sub> (typically = 3.3V) versions of equivalent FCT functions
- Edge-rate control circuitry for significantly improved noise characteristics
- · Power-off disable feature
- ESD > 2000V
- · Matched rise and fall times
- Fully compatible with TTL input and output logic levels
- Extended commercial range of -40°C to +85°C

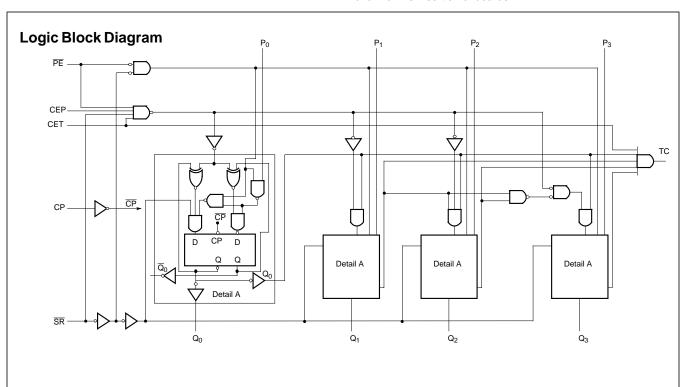
# 4-Bit Binary Counter

• Sink current 64 mA (Com'l), 32 mA (Mil) Source current 32 mA (Com'l), 12 mA (Mil)

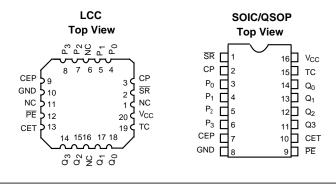
#### **Functional Description**

The FCT163T is a high-speed synchronous modulo-16 binary counter. It is synchronously presettable for application in programmable dividers and has two types of count enable inputs plus a terminal count output for versatility in forming synchronous multi-staged counters. The FCT163T has a Synchronous Reset input that overrides counting and parallel loading and allows the outputs to be simultaneously reset on the rising edge of the clock.

The outputs are designed with a power-off disable feature to allow for live insertion of boards.



# **Pin Configurations**





#### Function Table<sup>[1]</sup>

|    | Inp | uts | Action on the Rising |                                       |  |
|----|-----|-----|----------------------|---------------------------------------|--|
| SR | PE  | CET | CEP                  | Clock Edge(s)                         |  |
| L  | Х   | Х   | Х                    | Reset (Clear)                         |  |
| Н  | L   | X   | Х                    | Load (P <sub>n</sub> Q <sub>n</sub> ) |  |
| Н  | H   | Н   | H                    | Count (Incremental)                   |  |
| H  | H   | L   | X                    | No Charge (Hold)                      |  |
| H  | H   | X   | L                    | No Charge (Hold)                      |  |

### **Pin Description**

| Name | Description                            |
|------|--|
| CEP  | Count Enable Parallel Input            |
| CET  | Count Enable Trickle Input             |
| СР   | Clock Pulse Input (Active Rising Edge) |
| SR   | Synchronous Reset Input (Active LOW)   |
| Р    | Parallel Data Inputs                   |
| PE   | Parallel Enable Input (Active LOW)     |
| Q    | Flip-Flop Outputs                      |
| TC   | Terminal Count Output                  |

# Maximum Ratings<sup>[2,3]</sup>

| (Above which the useful life may be impaired. For user guidelines, not tested.) |
|---|
| Storage Temperature65°C to +150°C   |
| Ambient Temperature with Power Applied65°C to +135°C                            |
| Supply Voltage to Ground Potential0.5V to +7.0V                                 |
| DC Input Voltage0.5V to +7.0V   |
| DC Output Voltage0.5V to +7.0V  |
| DC Output Current (Maximum Sink Current/Pin) 120 mA                             |
| Power Dissipation0.5W   |
| Static Discharge Voltage>2001V<br>(per MIL-STD-883, Method 3015)                |

### **Operating Range**

| Range                   | Range | Ambient<br>Temperature | V <sub>CC</sub> |
|-------------------------|-------|------------------------|-----------------|
| Commercial              | All   | –40°C to +85°C         | 5V ± 5%         |
| Military <sup>[4]</sup> | All   | –55°C to +125°C        | 5V ± 10%        |

#### **Electrical Characteristics** Over the Operating Range

| Parameter        | Description                                 | Test Condition  | S     | Min. | <b>Typ.</b> <sup>[5]</sup> | Max. | Unit |
|------------------|---|---|-------|------|----------------------------|------|------|
| V <sub>OH</sub>  | Output HIGH Voltage                         | V <sub>CC</sub> =Min., I <sub>OH</sub> =-32 mA          | Com'l | 2.0  |                            |      | V    |
|                  |   | V <sub>CC</sub> =Min., I <sub>OH</sub> =-15 mA          | Com'l | 2.4  | 3.3                        |      | V    |
|                  |   | V <sub>CC</sub> =Min., I <sub>OH</sub> =-12 mA          | Mil   | 2.4  | 3.3                        |      | V    |
| V <sub>OL</sub>  | Output LOW Voltage                          | V <sub>CC</sub> =Min., I <sub>OL</sub> =64 mA           | Com'l |      | 0.3                        | 0.55 | V    |
|                  |   | V <sub>CC</sub> =Min., I <sub>OL</sub> =32 mA           | Mil   |      | 0.3                        | 0.55 | V    |
| V <sub>IH</sub>  | Input HIGH Voltage                          |   | •     | 2.0  |                            |      | V    |
| V <sub>IL</sub>  | Input LOW Voltage                           |   |       |      |                            | 0.8  | V    |
| V <sub>H</sub>   | Hysteresis <sup>[6]</sup>                   | All inputs  |       |      | 0.2                        |      | V    |
| V <sub>IK</sub>  | Input Clamp Diode Voltage                   | V <sub>CC</sub> =Min., I <sub>IN</sub> =-18 mA          |       |      | -0.7                       | -1.2 | V    |
| I <sub>I</sub>   | Input HIGH Current                          | V <sub>CC</sub> =Max., V <sub>IN</sub> =V <sub>CC</sub> |       |      |                            | 5    | μΑ   |
| I <sub>IH</sub>  | Input HIGH Current                          | V <sub>CC</sub> =Max., V <sub>IN</sub> =2.7V            |       |      |                            | ±1   | μΑ   |
| I <sub>IL</sub>  | Input LOW Current                           | V <sub>CC</sub> =Max., V <sub>IN</sub> =0.5V            |       |      |                            | ±1   | μΑ   |
| Ios              | Output Short Circuit Current <sup>[7]</sup> | V <sub>CC</sub> =Max., V <sub>OUT</sub> =0.0V           |       | -60  | -120                       | -225 | mA   |
| I <sub>OFF</sub> | Power-Off Disable                           | V <sub>CC</sub> =0V, V <sub>OUT</sub> =4.5V             |       |      |                            | ±1   | μΑ   |

- H = HIGH Voltage Level. L = LOW Voltage Level. X = Don't Care.

  Unless otherwise noted, these limits are over the operating free-air temperature range.

  Unused inputs must always be connected to an appropriate logic voltage level, preferably either V<sub>CC</sub> or ground.
- T<sub>A</sub> is the "instant on" case temperature.
- Typical values are at  $V_{CC}$ =5.0V,  $T_A$ =+25°C ambient. This parameter is specified but not tested.
- Not more than one output should be shorted at a time. Duration of short should not exceed one second. The use of high-speed test apparatus and/or sample and hold techniques are preferable in order to minimize internal chip heating and more accurately reflect operational values. Otherwise prolonged shorting of a high output may raise the chip temperature well above normal and thereby cause invalid readings in other parametric tests. In any sequence of parameter tests, I<sub>OS</sub> tests should be performed last.



# Capacitance<sup>[6]</sup>

| Parameter        | Description        | Typ. <sup>[5]</sup> | Max. | Unit |
|------------------|--------------------|---------------------|------|------|
| C <sub>IN</sub>  | Input Capacitance  | 5                   | 10   | pF   |
| C <sub>OUT</sub> | Output Capacitance | 9                   | 12   | pF   |

# **Power Supply Characteristics**

| Parameter        | Description                                      | Test Conditions   | <b>Typ.</b> <sup>[5]</sup> | Max.                | Unit   |
|------------------|--|---|----------------------------|---------------------|--------|
| I <sub>CC</sub>  | Quiescent Power Supply Current                   | $V_{CC}$ =Max., $V_{IN}$ ≤0.2V, $V_{IN}$ ≥ $V_{CC}$ -0.2V   | 0.1                        | 0.2                 | mA     |
| Δl <sub>CC</sub> | Quiescent Power Supply Current (TTL inputs HIGH) | V <sub>CC</sub> =Max., V <sub>IN</sub> =3.4V, <sup>[8]</sup><br>f <sub>1</sub> =0, Outputs Open   | 0.2                        | 2.0                 | mA     |
| I <sub>CCD</sub> | Dynamic Power Supply Current <sup>[9]</sup>      | V <sub>CC</sub> =Max., One Bit Toggling, Load Mode, 50% Duty Cycle, Outputs Open, CEP=CET=PE=GND, SR=V <sub>CC</sub> , V <sub>IN</sub> ≤0.2V or V <sub>IN</sub> ≥V <sub>CC</sub> -0.2V  | 0.06                       | 0.12                | mA/MHz |
| l <sub>C</sub>   | Total Power Supply Current <sup>[10]</sup>       | $\begin{array}{c} V_{CC}\text{=}Max.,  f_0\text{=}10 \text{ MHz, Load Mode,} \\ 50\% \text{ Duty Cycle, Outputs Open,} \\ \text{One Bit Toggling at } f_1\text{=}5 \text{ MHz,} \\ \text{CEP=CET=PE=GND,} \\ \overline{\text{SR}}\text{=}V_{CC},  V_{\text{IN}}\text{\leq}0.2\text{V or } V_{\text{IN}}\text{\geq}V_{CC}\text{-}0.2\text{V} \\ \end{array}$ | 0.7                        | 1.4                 | mA     |
|                  |  | $V_{CC}=Max.$ , $f_0=10$ MHz, Load Mode, 50% Duty Cycle, Outputs Open, One Bit Toggling at $f_1=5$ MHz, CEP=CET= $\overline{PE}=GND$ , $\overline{SR}=V_{CC}$ , $V_{IN}=3.4V$ or $V_{IN}=GND$   | 1.2                        | 3.4                 | mA     |
|                  |  | $V_{CC}=Max.$ , $f_0=10$ MHz, Load Mode,<br>50% Duty Cycle, Outputs Open,<br>Four Bits Toggling at $f_1=5$ MHz,<br>$CEP=CET=\overline{PE}=GND$ ,<br>$\overline{SR}=V_{CC}$ , $V_{IN}\le 0.2V$ or $V_{IN}\ge V_{CC}-0.2V$  | 1.6                        | 3.2 <sup>[11]</sup> | mA     |
|                  |  | $\begin{array}{c} V_{CC}\text{=}Max., f_0\text{=}10 \text{ MHz, Load Mode,} \\ 50\% \text{ Duty Cycle, Outputs Open,} \\ \text{Four Bits Toggling at } f_1\text{=}5 \text{ MHz,} \\ \text{CEP=CET=PE=GND, SR=V}_{CC}, \\ V_{\text{IN}}\text{=}3.4\text{V or V}_{\text{IN}}\text{=}\text{GND} \end{array}$   | 2.9                        | 8.2 <sup>[11]</sup> | mA     |

#### Notes:

8. Per TTL driven input ( $V_{IN}$ =3.4V); all other inputs at  $V_{CC}$  or GND.

This parameter is not directly testable, but is derived for use in Total Power Supply calculations.

9. This parameter is not directly testable, but is do....

10. I<sub>C</sub> = I<sub>QUIESCENT</sub> + I<sub>INPUTS</sub> + I<sub>DYNAMIC</sub>

I<sub>C</sub> = I<sub>CC</sub>+ΔI<sub>CC</sub>D<sub>H</sub>N<sub>T</sub>+I<sub>CCD</sub>(f<sub>0</sub>/2 + f<sub>1</sub>N<sub>1</sub>)

I<sub>CC</sub> = Quiescent Current with CMOS input levels

Aloc = Power Supply Current for a TTL HIGH input

Alcc = Power Supply Current for a TTL HIGH input (V<sub>IN</sub>=3.4V)

D<sub>H</sub> = Duty Cycle for TTL inputs HIGH

N<sub>T</sub> = Number of TTL inputs at D<sub>H</sub>

I<sub>CCD</sub> = Dynamic Current caused by an input transition pair (HLH or LHL)

f<sub>0</sub> = Clock frequency for registered devices, otherwise zero

= Input signal frequency

N<sub>1</sub> = Number of inputs changing at f<sub>1</sub>
 All currents are in milliamps and all frequencies are in megahertz.
 Values for these conditions are examples of the I<sub>CC</sub> formula. These limits are specified but not tested.



# Switching Characteristics Over the Operating Range

|                                      |  | CY54FC               | T163T    | CY74FC               | T163CT     |      |                          |
|--------------------------------------|--|----------------------|----------|----------------------|------------|------|--------------------------|
|                                      |  |                      | Military |                      | Commercial |      |                          |
| Parameter                            | Description                                  | Min. <sup>[12]</sup> | Max.     | Min. <sup>[12]</sup> | Max.       | Unit | Fig. No. <sup>[13]</sup> |
| t <sub>PLH</sub><br>t <sub>PHL</sub> | Propagation Delay CP to Q<br>(PE Input HIGH) | 2.0                  | 11.5     | 1.5                  | 5.8        | ns   | 1, 5                     |
| t <sub>PLH</sub><br>t <sub>PHL</sub> | Propagation Delay CP to TC (PE Input LOW)    | 2.0                  | 10.0     | 1.5                  | 5.2        | ns   | 1, 5                     |
| t <sub>PLH</sub><br>t <sub>PHL</sub> | Propagation Delay CP to TC                   | 2.0                  | 16.5     | 1.5                  | 7.8        | ns   | 1, 5                     |
| t <sub>PLH</sub><br>t <sub>PHL</sub> | Propagation Delay CET to TC                  | 1.5                  | 9.0      | 1.5                  | 4.4        | ns   | 1, 5                     |
| t <sub>S</sub>                       | Set-Up Time, HIGH or LOW P to CP             | 5.5                  |          | 3.5                  |            | ns   | 4                        |
| t <sub>H</sub>                       | Hold Time, HIGH or LOW P to CP               | 2.0                  |          | 1.5                  |            | ns   | 4                        |
| t <sub>SU</sub>                      | Set-Up Time HIGH or LOW<br>PE or SR to CP    | 13.5                 |          | 7.6                  |            | ns   | 4                        |
| t <sub>H</sub>                       | Hold Time HIGH or LOW PE or SR to CP         | 1.5                  |          | 1.0                  |            | ns   | 4                        |
| t <sub>SU</sub>                      | Set-Up Time HIGH or LOW<br>CEP or CET to CP  | 13.0                 |          | 7.6                  |            | ns   | 4                        |
| t <sub>H</sub>                       | Hold Time HIGH or LOW<br>CEP or CET to CP    | 0                    |          | 0                    |            | ns   | 4                        |
| t <sub>W</sub>                       | Clock Pulse Width (Load)<br>HIGH or LOW      | 5.0                  |          | 4.0                  |            | ns   | 5                        |
| t <sub>W</sub>                       | Clock Pulse Width(Count)<br>HIGH or LOW      | 8.0                  |          | 5.0                  |            | ns   | 5                        |

Minimum limits are specified but not tested on Propagation Delays.
 See "Parameter Measurement Information" in the General Information section.

# **Ordering Information**

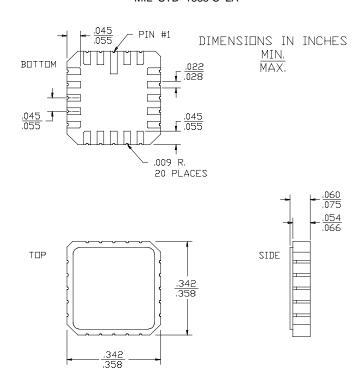
| Speed (ns) | Ordering Code        | Package<br>Name | Package Type                    | Operating<br>Range |
|------------|----------------------|-----------------|---------------------------------|--------------------|
| 5.8        | CY74FCT163CTQCT      | Q1              | 16-Lead (150-Mil) QSOP          | Commercial         |
|            | CY74FCT163CTSOC/SOCT | S1              | 16-Lead (300-Mil) Molded SOIC   |                    |
| 11.5       | CY54FCT163TLMB       | L61             | 20-Square Leadless Chip Carrier | Military           |

Document #: 38-00285-B

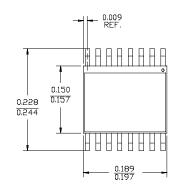


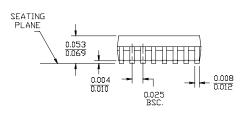
# **Package Diagrams**

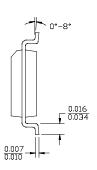
## 20-Pin Square Leadless Chip Carrier L61 MIL-STD-1835 C-2A



#### 16-Lead Quarter Size Outline Q1







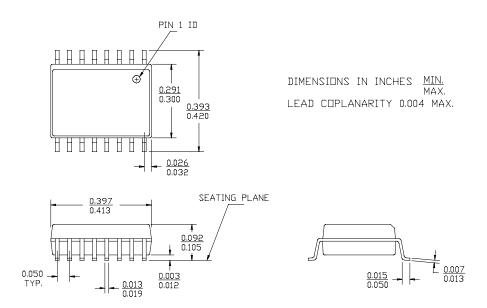
DIMENSIONS IN INCHES MIN. MAX.

LEAD COPLANARITY 0.004 MAX.



# Package Diagrams (continued)

#### 16-Lead Molded SOIC S1



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